

4. (Amended) A resin injection molded article according to claim 2, wherein

A₄ said fiber material is selected from the group consisting of synthetic fibers including nylon or polyester and natural fibers including hemp or cotton.

9. (Amended) A resin injection molded article according to claim 1, wherein at

least one part of said resin surface layer is a transparent resin layer.

A₅ 10. (Amended) A resin injection molded article according to claim 9, wherein

said two-dimensional reinforcing core material is provided with a design including at least one of a picture, a drawing, characters, and a pattern, and the transparent layer lies over said design.

11. (Amended) A resin injection molded article according to claim 1, which is

an electronic device casing or a part thereof.

16. (Amended) A resin injection molded article according to claim 15, wherein

said two-dimensional core material is one of a film, sheet, or net made of paper, plastic, metal, fiber product or a laminate thereof.

A₆ 17. (Amended) A resin injection molded article according to claim 15, wherein

said two-dimensional core material is provided with a design comprising at least one of a picture, a drawing, characters, and a pattern.

18. (New) A resin injection molded article according to claim 2, wherein at least one part of said resin surface layer is a transparent resin layer.

19. (New) A resin injection molded article according to claim 3, wherein at least one part of said resin surface layer is a transparent resin layer.

A₇ 20. (New) A resin injection molded article according to claim 4, wherein at least one part of said resin surface layer is a transparent resin layer.

21. (New) A resin injection molded article according to claim 5, wherein at least one part of said resin surface layer is a transparent resin layer.

22. (New) A resin injection molded article according to claim 6, wherein at least one part of said resin surface layer is a transparent resin layer.

23. (New) A resin injection molded article according to claim 7, wherein at least one part of said resin surface layer is a transparent resin layer.

24. (New) A resin injection molded article according to claim 8, wherein at least one part of said resin surface layer is a transparent resin layer.

25. (New) A resin injection molded article according to claim 2, which is an electronic device casing or a part thereof.

26. (New) A resin injection molded article according to claim 3, which is an electronic device casing or a part thereof.

27. (New) A resin injection molded article according to claim 4, which is an electronic device casing or a part thereof.

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28. (New) A resin injection molded article according to claim 5, which is an electronic device casing or a part thereof.

29. (New) A resin injection molded article according to claim 6, which is an electronic device casing or a part thereof.

30. (New) A resin injection molded article according to claim 7, which is an electronic device casing or a part thereof.

31. (New) A resin injection molded article according to claim 8, which is an electronic device casing or a part thereof.

32. (New) A resin injection molded article according to claim 10, which is an electronic device casing or a part thereof.